





Service Manual for Charmer

HTC Proprietary Confidential Treatment Requested

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HTC Corp.

Engineering Mobility





TITLE: Service Manual

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REV. NO.	DATE	CONTENTS	DEP.	REVISED	APP'D	STGE.PER.
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D. BOARD LEVEL 2.5 REPAIRS65





1. Introduction

This manual provides the technical information to support the service activities of Magician.

This document contains highly confidential information, so any or all of this document should not be revealed to any third party.

2. Product Specification

Platform

 Microsoft Pocket PC 2003 Phone Edition – English, Spanish, Traditional Chinese, Simplified Chinese,

Italian, Portuguese, German

- Dimensions: Main unit :108mm(L) *58mm(W) * 18.1 mm(T)
- Weight :150g with battery pack

Processor

TI OMAP 850

Memory

- Flash ROM: 128MB
- Flash RAM: 64MB mobile Double Data Rate (DDR)

LCD Module

- 2.8 "240 X320 dots resolution
- 64K-color TFT Transflective LCD with white LED back light.
- Sensitive touch screen
- Support screen rotation battery meter, and key lock icons on the lower right corner of today screen

GSM/EDGE functional

- Audio codec:AMR,EFR,FR,HR
- Quad-band 850/900/1800/1900MHz
- Internal antenna for tri-band GSM
- SMS (MO,MT) concatenated SMS (640 characters)
- Supplement services
 - ~ Call holding/waiting/forwarding
 - ~ Call barring





- ~ CLI (Calling Line Identity)
- ~ Display own number
- ~ Network selection
- ~ Cell broadcast
- ~ Multi-party conference call
- ~ Spool icon
- ~ Phase 2+unstructured supplementary
- ~ Network Lock
- ~ CPHS

DEGE Functionality

- EGPRS class B
- Multi-slot class 10
- PBCCH
- Link Adaptation and Incremental Redundancy

SIM

- Accept 1.8V and 3V operation
- SIM Application Tool Kit release 98 class 3
- Over the Air (OTA) programming
- FND
- AND
- SDN
- Security PIN 1&2

Stylus

• Lock type mechanism

Keyboard/button/switch

- One power button
- One voice dial/voice record (long press) on the same key
- One volume control button (up and down)
- One Camera capture (portrait mode default)
- One 5-way navigation Pad
- Send/Hands-free button
- End button
- 2 AP buttons (Start or Portal (by operator request)-left button, OK-right button)





Notification

- One bi-color LED (Green and Red) LED for GSM standby, GSM message, GSM network status, notification, and charging ststus
- Blue LED for Bluetooth notification .
- Notification by Sound and Message on the display
- Vibrator for notification

Audio

- Built-in Microphone,
- Receiver
- Speaker
- Loud speaker for hands-free support
- Full duplex
- Audio sampling rate
 16-bits with 8KHz, 11KHz, 16KHz, 22KHz, 44.1KHz,
- AMR/AAC/WAV/WMA/MP3 stereo

Camera

- Color CMOS VGA/1.3Mega-Pixel camera with macro
- Preview Mirror

Power

- Battery
 - ▶ Removable rechargeable Lithium Ion Polymer battery, 1200mAh (Typical)
 - ▶ Charging time: less than 4 hours

Battery life:

- ▶ WMA:12 hours (Magneto test case)
- ▶ WMV:8 hours (Magneto test case)
- ▶ Talk time : 3.5~5 hours (at nominal RF Tx power level)
- ▶ Standby time: 150~200hors
- AC Adapter
 - ▶ AC input: 100 ~ 240 Vac, 50/60Hz
 - ▶ DC Output voltage: 5V and 1A

Interface

- Infrared Port IrDA SIR
- One Audio Jack (2.5)





- 1.8V and 3V SIM card
- One SDIO/MMC card slot
- One External antenna connector
- One Mini USB connector

Device to Device connectivity

Bluetooth

- Compliant with v1.2
- Class 2 transmit power
- Support profiles :
 - V Generic Access
 - V Generic Object Exchange profile
 - V Serial Port Profile
 - V Headset Profile
 - V Object Push Profile
 - V DUN Client Profile
 - V File Transfer Profiler
 - V AV Profiler
 - V PAN Profile
 - V HID Profile
 - V Hands-free Profile
- Infrared IrDA SIR
- Mini-USB
- SDIO/MMC

Accessories

- Sync. Cable (Mini-USB/USB)
- Carrying Case
- AC adapter W/ power plug
- Car adapter
- Car Kit (capable of muting car stereo when incoming call or call proceeding)
- Stereo Wired headset-stereo earpiece with microphone
- User manual ,quick start guide, sync, software CD
- Stereo Bluetooth headset-mono earphone with microphone





- Optional Battery (1200mAh)
- Car kit w/car stereo mute function
- Travel charger (optional)
 - ~Mini-USB
 - ~1 slot for 2nd battery charging
- Cradle (optional)

Regulatory

- R&TTE: EMC/EMI,CEM, Safety
- PTCRB
- FCC
- Microsoft Window Mobile Version 5.0
- USB Certification
- WiFi certification

Value Added Applications

MASD

- Photo Album with editing picture capability
- · Camera capture utility
- Camcorder (H.263 and MPEG4 encoder and decoder)
- Zip
- Polyphonic MIDI Ring tone Engine
- SmartDial

MSD

- MMS with video clip support
- Voice dial via device, wire headset, or BT headset
- JAVA virtual machine (J2ME CLDC, MIDP 2.0,)
- FAX
- OMA DRM2.0
- Blackberry e-mail client (operator dependent)

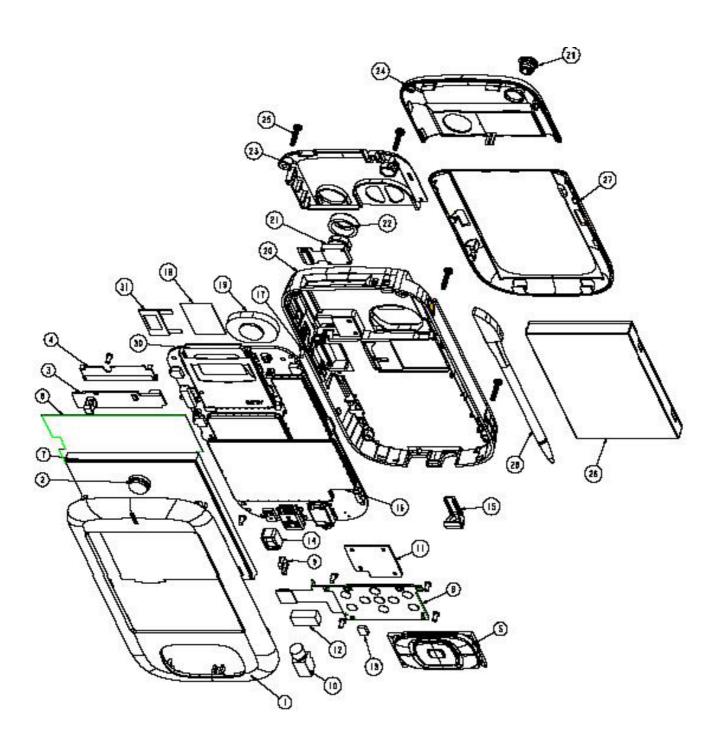
SW

- Wireless Modem (IR,USB, Bluetooth)
- · Key lock ,screen rotation ,and battery meter

2. Exploded Diagram











3. Assembling and Disassembling

3.1 Disassembling



Tools needed for Assembling and Disassembling the Harrier.

- 1. Lens Cleaning Tissue.
- 2. Philip Screw Driver 000X50
- 3. Philip Screw Driver 2.5X40.
- 4. Torex Screw Driver T6X40
- 5. Tweezers
- 6. Special Made Plastic Stick.

 Tweezers.(Suggest to use plastic made)



- 2. Remove the SD Card Filler.
- 3. Remove the Antenna Insert Rubber. as indicated on the left.



Next, Remove the battery cover by slightly push backward the battery cover .

Note: Cover-Battery 71H00279-0XM







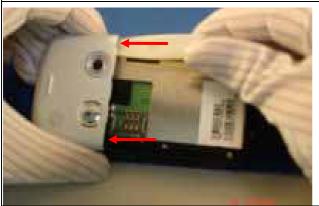
.Release the Battery P/N: 35H00051-00

Warning: To reduce risk of fire or burns, do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water. Replace only with specified batteries. Recycle or dispose of used batteries properly.





Turn left the Philips screw driver and looses the hook of antenna cover.



To remove antenna cover

Please use Precision Plastic special tool flat (θ) type 1.2 mm and insert in to the two hole as shown on picture.

Insert in angle:30 °

Cover-Antenna P/N: 74H00375-0XM







Remove the 2 screws for release internal antenna.



Next, remove the Antenna, unlock the connector lock with the plastic stick.

Antenna P/N :36H00345-00M



For Camera FPC, to lift the connector lock upwards from both ends at the same time as indicated in the picture. The angle must not exceed 90 degrees.

Camera P/N: 54H00134-01M







Next , remove 2 screws to disassemble bezel and housing



Next, start disassembly the housing cover Please be noticed that improper way of disassembly may caused the cover worn easily

- 1. Insert the plastic stick to the gap between front and rear cover deep inside.
- 2. Move the stick slightly from lower side to upper to release the 6 hooks (3 each at both side)



Release all hooks at both side





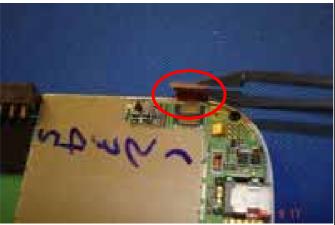


For Camera FPC, lift the connector lock upwards from both ends at the same time as indicated in the picture. The angle must not exceed 90 degrees.



Next, disassembly the speaker connector using tweezers and housing.

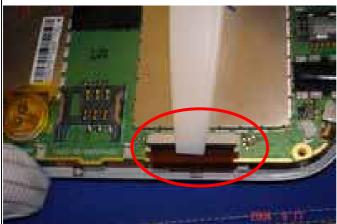
Speaker P/N:36H00338-00M



Next, disconnect switch board and Main board FPC.







Next, remove the LCD from MB.

- 1.Unlock the LCD connector with plstic special tool (hook side)
- 2. Take out the FPC with plastic tweezers.



Remove 2 screws on main board to disassemble main board and bezel assembly.

Note that screw P/N is 72H00724-00M.



Remove the audio jack holder with plastic tweezers

Note that holder P/N is 71H00960-00M







Separate the Audio Daughter Board from the Main Board as indicated on the left.

Note that Daughter Board P/N is: 51H00322-00M



- 1. Remove Vibrator from bezel.
- 2.Remove Spacer on switch board
- 3.Remove on GASKET switch board
- 4.Remove gasket on switch board

Note those P/N 1: **36H00180-00M**

2:76H00748-00M

3:72H00498-00M

4:72H00548-00



Remove 4 screws on switch board to disassemble switch board and bezel assembly.

Note that screw P/N is 72H00724-00M.







Next, Remove the Navigation keypad rubber from the bezel.

Note that Navigation key pad Assembly P/N is: **74H00400-00M**



Next, to separate the LCD from the bezel as indicated on the left.

Note that LCM P/N is:60H00032-00(Samsung)/60H00037-00 M(Toppoly)



Remove the Receiver from bezel with plastic tweezers

Note that receiver P/N:36H000253-01M

Done for disassembly

3-2 Assembling

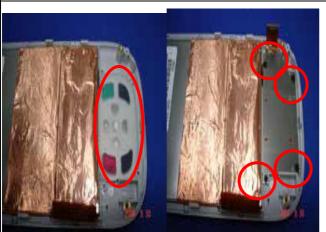






- 1.Assembly receiver into its place on the bezel LCM assembly :
- 2-1Insert LCM into its place on the bezel , the angle about 30 degrees .
- 2-2.Put down LCM.

Note: if a new LCD needs to be replaced, please paste two copper foils before assembly



- 1.Put the Rubber keyboard on the bezel.

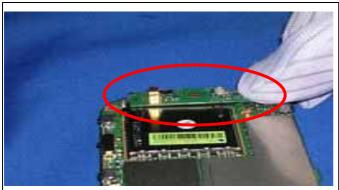
 Note: there're 4 guide pins on bezel, so please aim at them when the Rubber keyboard is put on it.
- 2. Put the switch board on Action button and fasten 4 screws as indicated on the left.



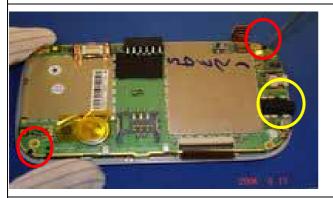
- 1. Put the gasket on switch board.
- 2.Put the gasket on switch board
- 3. Put the spacer on switch board
- 4. Put the Vibrator into its place on the bezel.



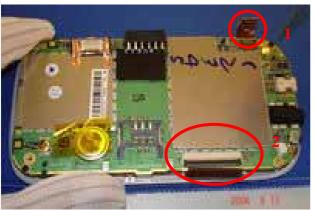




Assemble the Audio daughter board on main board and please pay attention on the Antenna location.



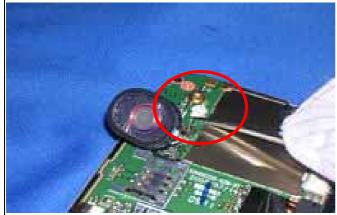
- 1. Put the Holder on audio jack.
- 2. Fasten 2 screws to fix main board on bezel as indicated on the left.



- 1. Press down S/W board FPC connector into the connector of M/B .
- 2. Insert LCM FPC into M/B connector.



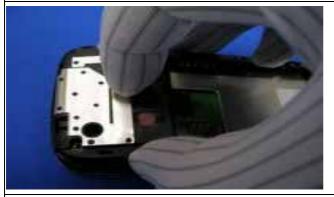




Insert the speaker connector into the connector of the M/B.



- 1. Assembly the housing.
- Please set the volume button on the center before assembly.
- 2. Assemble the camera module on main board.



Set up the antenna on the top of the unit.



Fasten 4 screws on rear side







Assembly the antenna cover

Note:1. insert from the top of hooks 2.then press down the cover



- 1. put the battery into the unit.
- 2. slightly push forward the battery cover .



- 1. Insert the Stylus.
- 2. Insert SD Card Filler into the slot.
- 3. Insert the Antenna Rubber. as indicated on the left.



The assembly procedure is done.





The Unit Assembly is done already.

3-3. LCM assembly notice

- 1. Stick 2 Mylars on the back of the LCM (Mylar P/N: 76H00967-00M) as figure1
- 2. Apply the copper foil to LCM back side as figure2 (Copper foil P/N: 72H00782-00M)



Figure 1



Figure 2





4. Diagnostic Program and Win CE test item

4.1 Tools required

SD card with Diagnostic program loaded.

4.2 How to enter Diagnostic Program

- (1) Insert SD card with Diagnostic program loaded to the unit.
- (2) Press and hold Capture + Reset to enter diagnostic mode to perform the test.

4.3 List of Diagnostic / WinCE Test Items

	No.	Item	Description	Remark
	1	SDRAM Test	Check SDRAM Size/Write/Read	
	2	Display Test	Test the LCD display quality	
	3	Touch Test	Touch panel calibration test.	
	4	LED Test	Red/green/amber/key LED on/off test	
	5	Key Test	All buttons (Key) press/release test.	
	6	B.L Test	Three levels Backlight test.	
	7	Timer Test	Timer test	
apo	8	SD Test	SD card read/write/lock/unlock test.	
Diag. Program mode	9	Battery Test	Check battery capacity, current, voltage	
grar	Α	Vibrator Test	Test the function of Battery	
. Pro	В	Checksum Test	Calculation ROM checksum Test.	
Diag	С	Msys- Fromat	Clear call duration (including Talk time and E-user data)	
	D	SPK Play Test	Playback a simulation wave test.	
	Е	Rev Play test	Playback to Receiver	
	F	Hst Play	Playback to 3-ring earphone	
	G	IntRec- SpkOut	Internal record & playback	
	Н	IntRec- RevOut	Internal record & playback with Receiver	
	I	IntRec-HstOut	Internal record & earphone out	
	J	HstRec-HstOut	Earphone MIC record & earphone out	
		Upload To SD	To SD For HTC Service Center upload Diagnostic to SD card.	





n CE	1	USB Test	Suggest to test in Windows CE	
Wii	2	SIR Test	Suggest to test in Windows CE	

4.4 Test Items Operation

How to select test item: Using navigation button -"Up" or "Down" to select the test items

How to execute the test program: Press "Action" button to start each of test items.

	No.	Item	Description	
	1	RAM Test	Press Action button to process SDRAM test Display Size and read/write test. It	
	1	70 100	will show OK if pass. Stop on fail.	
			Unit prompts for different display page to detect the defect of LCD, lines or	
			dots.	
			First display is Multiple Color,	
			Press Action to Red Color	
	2	Display Test	Press Action to Green Color	
		., .,	Press Action to Blue Color	
			Press Action to Dark Color	
			Press Action to White Color	
g			Press Action to Gary Color	
ШÕШ			Press Action to return Test Menu	
Diag. program mode	3	Touch Test	Tap the cross mark (+) with stylus on the correct location. Fail if no reaction	
prog		LED Test	Action LED: Green→ Red→Blue Bluetooth	
ag.	4		Action LED: Green→ GSM	
			Action keypad LED	
	5	Key Test	Follow the indication on device to press buttons for test.	
		Backlight Test	Press "Action to test LED and brightness level of LCD (three stages),	
	6	Backlight rest	and then return Test Menu.	
	7	Timer Test	Press Action to check if it shows "Test OK".	
	8	SD card Test	Lock SD card and insert to unit, then remove SD card	
	9	Battery Teat	Check battery capacity, current, voltage	
		Vibrator Test	Press Action, unit should vibrate, and then press Action to return Test	
	Α		Menu	
	В	Checksum Test	Press Action to calculate ROM checksum.	





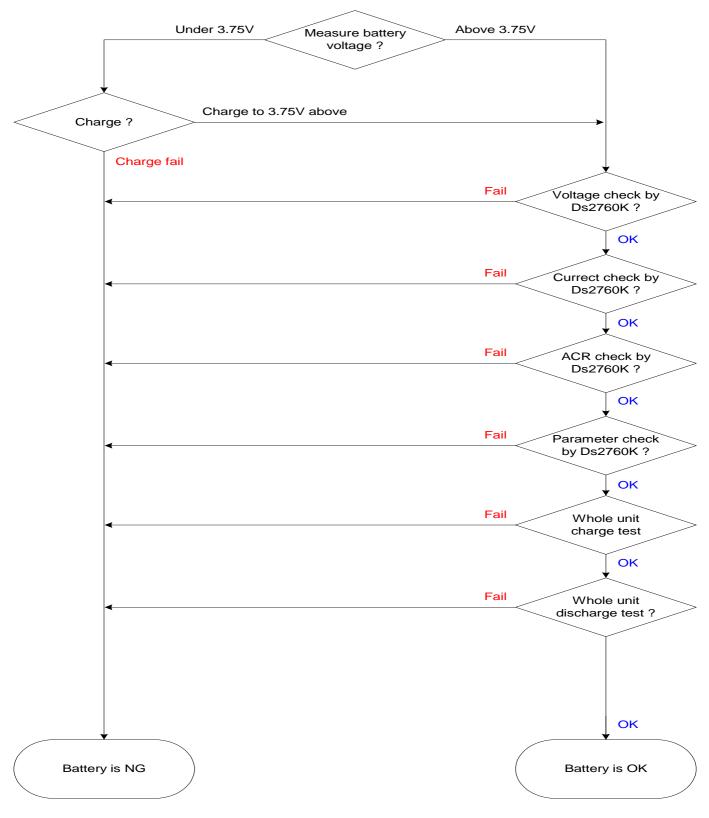
	С	Msys-Format	Press Action to clear call duration(talk time and end-user data)	
	D	Spk Play test	Playback to SPK	
	Е	Rev Play test	Receiver Playback test	
	F	Hst Play test	Earphone Playback test	
	G	IntRec Spkout	Intel Record and Speak out	
	Н	IntRec Revout	Intel Record and Receiver out	
	ı	IntRec Hstout	Intel Record and Earphone out	
	J	HstRec Hstout	Earphone Record and Earphone out	
CE	1	USB Test	Plug USB cable to connect UUT to PC then and check if USB OK or not.	
WinCE	2	SIR Test	Use a device that can support SIR function to connect UUT.	

5. Main Battery Re-certify Procedure

5.1 Flow Chart



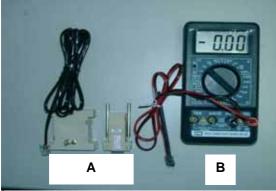








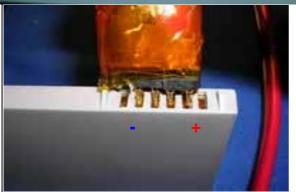
5.2 Measurement Procedure



Tools requirement:

- A. Battery testing fixture
- B. Multi-meter with battery detecting plug
- C. Win2000 or above OS PC system
- D. Ds2760K battery testing program.

Note: The Ds2760K program needs to installed onto PC in advance.



Step 1: Main battery voltage check

 To detect battery voltage by multi-meter through battery connector.



b. The battery voltage will appear on the multi-meter, make sure the voltage >= 3.75V above
If the voltage < 3.75V please charge the main battery and then re-check the battery voltage must > 3.75V.



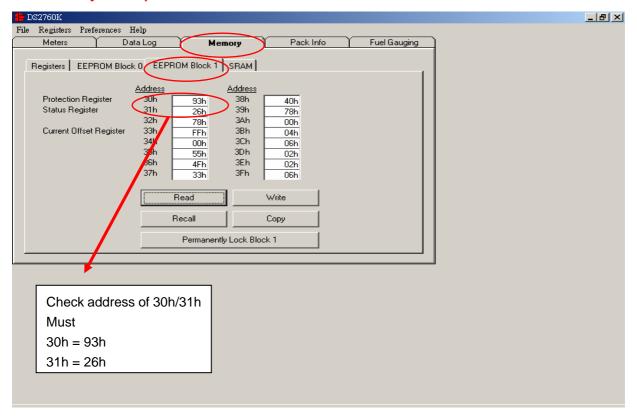




Step 2: Parameter check by DS2760K test program

 a. Contact battery to detect battery parameter by DS2760K program

The battery's core parameter areas as follows:



If the register address is incorrect, it means that the EEPROM is defective.







Step 3 : Whole unit charge test

Plug in AC adapter to unit, the charge light must be turn on (Red), If it is failed in charge test, replace another good battery for double check.



Step 4 : Whole unit discharge test

Unplug AC voltage, the charge light must be off, but the LCD screen must be still on display. If it is failed in discharge test, replace another good battery for double check.

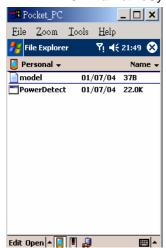




If you still have the misgiving for the battery you can execute rundown test to verify.

- 5.3 Battery Rundown Test Procedure
 - (A) Tool Requirement: (1) Windows 2000 or above (2) Battery Rundown Software
 (3) USB Cable or Cradle (4) ActiveSync 4.0 or above
 - (B) Please charge your unit to full capacity for battery (4 hours) before doing the test.

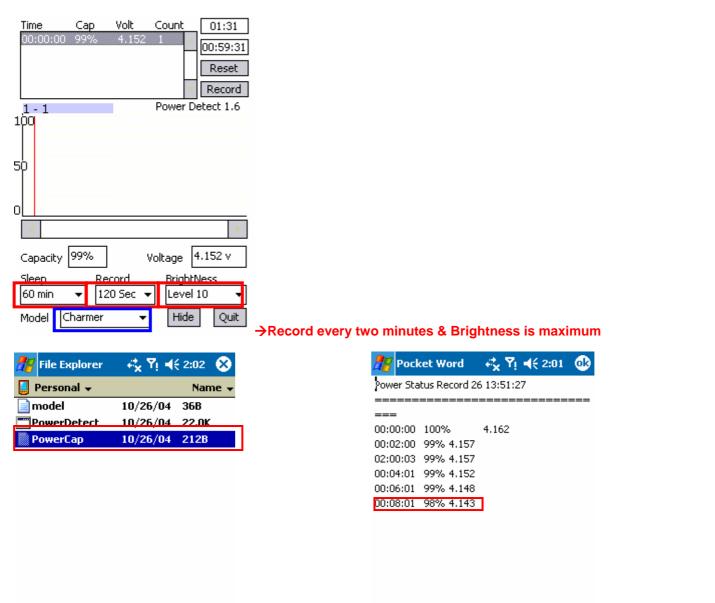
Step 1: It is required to save powerdetect.exe and model.txt in the same folder under WinCE via ActiveSync.



- Step 2: It is unnecessary to adjust power management setting by using rundown test program.
- Step 3: Execute powerdetect.exe under WinCE, it will enter Sleep Mode after **one**hour and generate a file named powercap.txt log.







New Edit View Tools 📬

Step 4: Tap powercap.txt log to check if the rest battery capacity. If under 72%, please replace a new battery.

Powercap.txt

Edit Open 🔺 📘 📱 🍶





Chapter 6 – Leakage current measurement

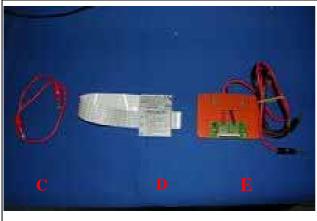
This is a quick method to measure if any abnormal leakage current on main board which caused high power consumption compare to GOOD main board.

- (1) Requirement:
 - Power Supply
 - Micro-current Meter
 - Current series JIG
 - CABLE
 - Battery JIG



Equipment need:

- A. Power Supply (set at 4 V /1A).
- B. Micro-Current Meter (support 0.5mA ~ 1A).



2. Fixture needed

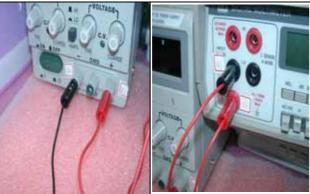
- C. Cable
- D. Battery with extension cable
- E. Current series jig.(with black and red cable)





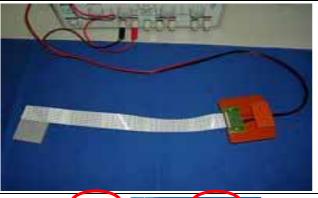


Connect cable (C) to positive polarity of power supply (A) and current meter (B)



4. Connect cable of fixture(E) to negative polarity of power supply (A) and current meter (B)

Note: black cable to power supply (A) and red cable to current meter (B)



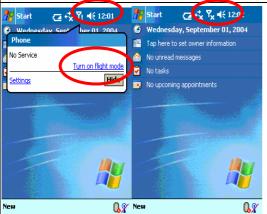
Setting is Ready now for testing(Don't turn the power on at this moment)

6.Turn on power supply (4V) and current meter (2A)

Set the unit to:

- * Flight mode
- * Turn on Bluetooth

Note : Need to put SIM card first on the unit.









7. Measure flight mode current

Setting display off:

start→settings-→System→backlight, set the cursor to Power Save, display will be off, in this condition, please check current value on the current meter,

Current value must under **65mA**, if over, it means M/B failed, please replace M/B for repair.

Unit is turn on and no back Light



8. Switch OFF the unit.

Unit is turn off and no display



12. Measure power off current Check current value on the current meter, Current value must under 5 mA, if over, it means M/B failed, please replace M/B for repair.





Conclusion:

If current consumption are passed at both of flight and power off mode, it means M/B is GOOD.

If there is any item FAILED at flight or power off mode, it means M/B is failed, please replace M/B for repair.

Measurement parameter

Measurement mode	Measured Current	REMARK
Flight Mode	Under 65mA	MB is good
(Idle mode)	Over 65mA	Fail, MB need to be futher repaired
POWER OFF	Under 5 mA	MB is good
(Sleeping mode)		Fail, MB need to be futher
	Over 5 mA	repaired





7. Cosmetic Inspection Criteria

6.1. Definition of Cosmetic Standard

B Standard is for refurbishment inspection.

7.2. Visual Inspection Requirements

2.1 Examination of the device shall be made with workbench light turned on.

Ambient illumination is to be 1000±20 lux.

- 2.2 The inspector shall examine the device at a distance of 30cm± 30degrees for approximately 5 seconds.
- 2.3 If a visual defect is noted, the inspector shall have an additional 7 seconds to closely examine the defect and classify it according the criteria table.

7.3. Definitions of Inspection Defects and Areas

Scratch: A linear cut that penetrated beyond the surface of the material.

A scratch can be felt by running your finger over it.

Dot / Dent: A recessed spot or void in the surface of the material.

Lint: A linear foreign object beyond the surface of the LCD

Bump: A hump in the surface of material

Area I: LCM, Bezel including phone key, APP button, action key and LED lens.

Area II: Keyboard, Housing, back side of battery, antenna cover, release button, stylus and side buttons.

Area III: Inner side of battery (not include battery), inside of SD connector, inside of USB port inside of Earphone jack and other area marked in the figure below.

D: Diameter/ L: Length/ W: Width/ Number: Number of defects/ S: Distance of dot to dot

Remark: 1. Crack is not allowed. 2. All dimensions in millimeters..

Area I



Area II



Area III







7.4. Cosmetic Criteria Table

	-				_		
	Specs Item	B standard		Specs Item	B standard		
	-	(Refurbishment specs)			(Refurbishment specs)		
	Bright dot**	Red + Green + Blue 2		Scratch	1) L 15mm, W 0.4mm		
		dots 0.1mm< D 0.3mm			2) Total number 5		
	Dark dot**	Dark dots 2 0.1mm< D		Spot	1) D < 1mm, S 10mm		
		0.3mm			2) Total number 4		
	Dark or Bright line	None	A O	Dent	1) D < 1mm, S 10mm		
			Area 3		2) Total number 4		
LCM*	Scratch	Total scratch number 3		Bump	1) D < 1mm, S 10mm		
		w 0.1mm 1.0mm L 2.0mm			2) Total number 4		
	1.1.4	Total number 2		D	1) L 3mm, W 0.254mm		
	Lint	0.03mm <w 0.01<="" td=""><td></td><td>Bur</td><td>2) No Hand Scrape</td></w>		Bur	2) No Hand Scrape		
		1.0mm L 2.0mm					
	Particle	Total number 3					
	Breakage on T/P	None	IR Cap	*Scratch	1) L 3mm, W 0.2mm		
	Breakage on 171	None	псоар	Coratori	2) Total number 3		
	T			<u> </u>			
	Scratch	1) L 3mm, W 0.15mm		Scratch	1) L<7mm, W<0.15mm		
		2) Total number 3			2) Total number<3		
	Spot	1) D < 0.3mm, S 15mm	Stylus	Protruding over the top of	None		
		2) Total number 3	,	bezel			
	Dent	1) D < 0.5mm, S 15mm		Deformed/ Missing/ Loosen	None		
		2) Total number 4		Ů			
Area 1	Bump	1) D < 0.5mm, S 15mm					
		2) Total number 4		<u> </u>	Г		
	Bur	1) L 3mm, W 0.254mm		Gap between touch panel	Gap < 0.9mm		
		2) No Hand Scrape		and bezel (Skip corner)			
	Bright mark	L 2.5mm W 0.25mm N 2		Gap between bezel and	Gap < 0.6mm		
	Dright mark	2.011111 11 0.2011111 11 2		housing	σαρ (σ.σ		
				Buttons on the bezel	Button needs to be pressed smoothly		
				Navigation button	Button needs to be pressed smoothly		
		1) 7,500 1/4 0.45,500	Gap	Gap between housing and			
	Scratch	1) L 7mm, W 0.15mm		battery, battery and battery	Gap < 0.5mm		
		2) Total number 3		lock			
	Spot	1) D < 0.7mm, S 15mm		Gap surrounding the buttons	1) 0.05mm <gap <0.6mm<="" td=""></gap>		
	Spot	2) Total number 4		on the side	2) Button needs to be pressed smoothly		
	Dent	1) D < 0.6mm, S 15mm			1) 0.05mm <gap <0.6mm<="" td=""></gap>		
Area 2	Dent	2) Total number 4			2) Button needs to be pressed smoothly		
	Rump	1) D < 0.6mm, S 15mm					
	Bump	2) Total number 4					
	Bur	1) L 3mm, W 0.254mm					
	Bur	2) No Hand Scrape					
	Bright mark	1) L 3.0mm, W 0.25mm					
	Bright mark	2) Total number 4					

^{*} The total of LCM defect number must be less than 5 counts.

^{**} The total of defected dots (bright dot and dark dots) must be less than 4.





8. OS, GSM Image Reflash Procedure System Requirement:

- -Windows 2000
- -USB Cable or Cradle
- -MTTY.exe
- -Master Unit with most update Rom Code
- -64 MB SD/MMC card SD card

Caution: The unit must have at least 70% of battery capacity before starting the re-flash process. Charge the battery in advance if necessary.

Note: For the master unit, you could prepare it on these following ways:

- Take one from Swap unit with most update Rom Code.
- Build one first by connecting to customer web for OS Upgrade/ Download Via RUU.

Execute RUU:

- 1.Boot up device into OS mode.
- 2. Allow USB connections in ActiveSync connection settings.



- 3. Connect with PC by USB cable.
- 4. Execute RUU program to re-flash ROM code.







- 1. Check "I understand the action indicated above and have reviewed the Read me"
- 2. Click "Next"

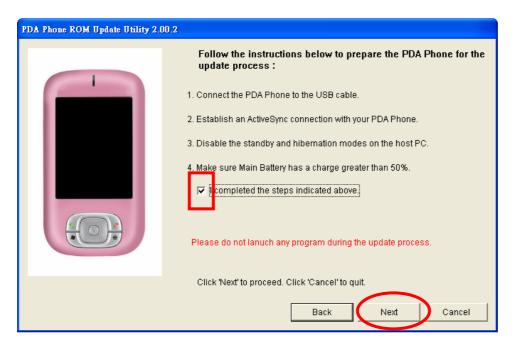




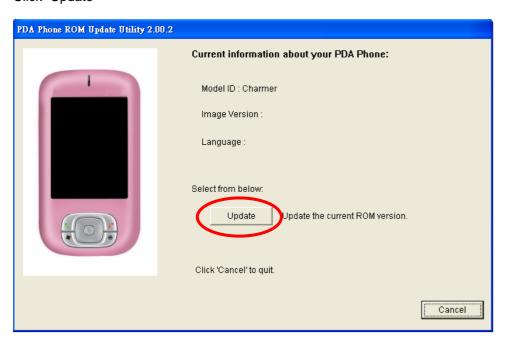


Check "I completed the steps indicated above"

Click "Next"



Click "Update"



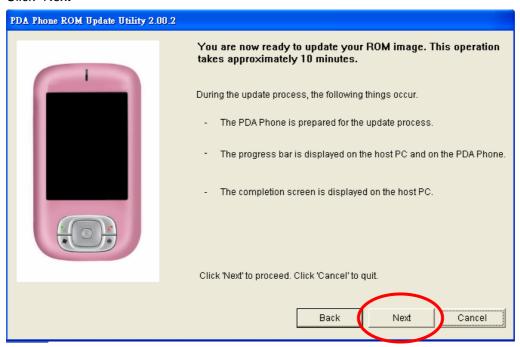




Click "Next"



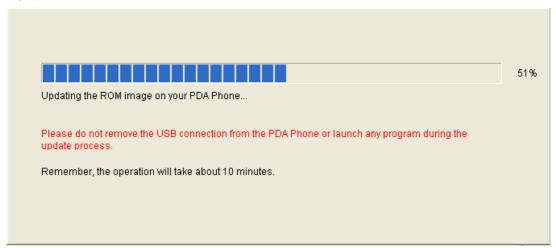
Click "Next"



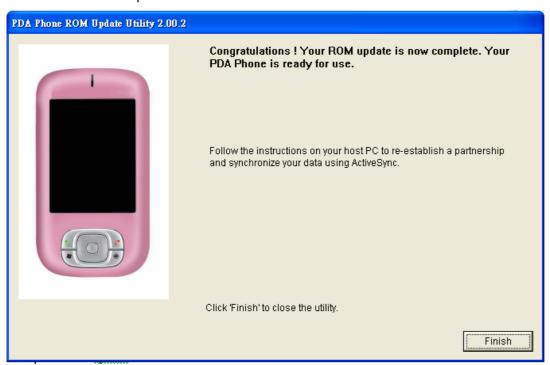




Next:



Done for ROM code updated







Execute hard reset!

Press and hold the Camera button+ Comm Manager button, at the same time use the stylus to press the RESET button.until the Following Hard Reset Screen is pop out, " Press Send to restore factory default or press others key to quit "

You can press Talk/Send key to do Hard Reset.



A. Upload most update code from master unit to SD /MMC card.

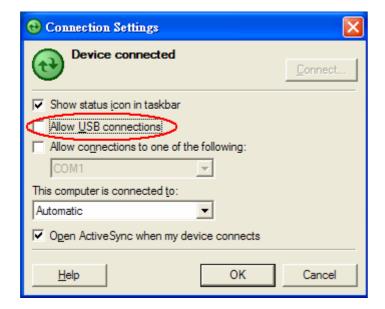
(You Only need to do this ONCE when New Update is received)

Requirement: (1) Mtty.exe tool ver. 116 (2) USB cable (3) Window2000 or above (4) Master unit with most update ROM image

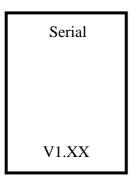
1. Uncheck USB and COM1 in Connection Settings in ActiveSync if you have installed the ActiveSync in your PC and make sure the USB port is available.







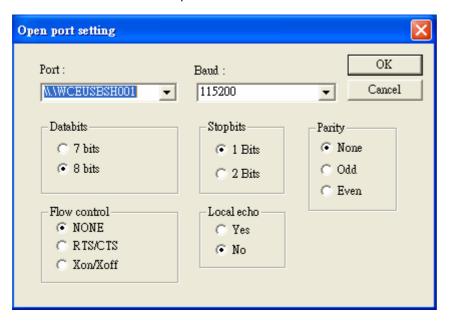
2. Set the Unit into Bootloader Mode (While Press **Capture + Reset**), wait for Serial on display. Message on PDA Screen:





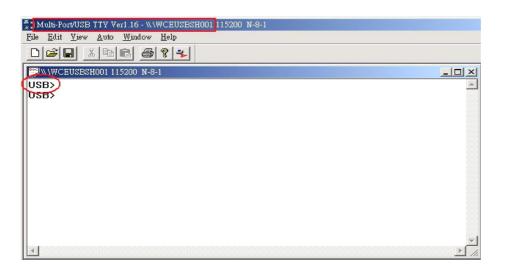


3. Connect the unit to the PC with **USB cable or USB cradle**, unit display will change to **USB**, and then open MTTY116.exe to select USB port.



- 4. Insert 64 MB SD or MMC card into SD slot of PDA Phone
- 5. On the PC side, Select OK and press ENTER.

Following display will be shown:





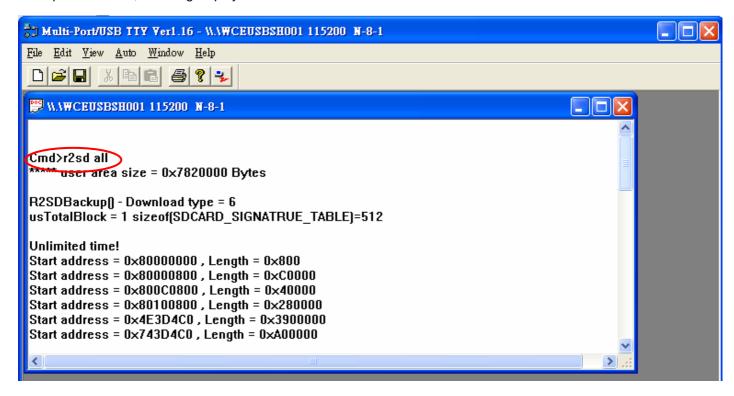


6. The prompt "USB>" will appear, to UPLOAD then type.

USB>r2sd all

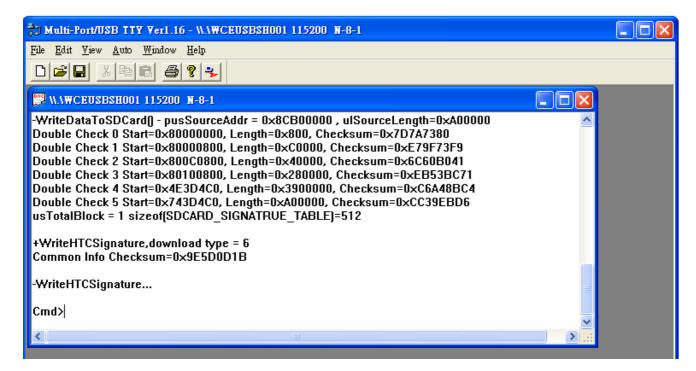
(Please notice the blank space between r2s and all)

Then press ENTER, following display will be shown:









Now the upload to SD card is done!

Take out the SD card from PDA phone and mark it according to the Language you build for.

CAUTION! DO NOT REMOVE THE USB CABLE FROM THE PC OR PDA, FAIL TO DO SO MAY CAUSE DEVICE UNIT FAIL TO BOOT.





B. Use Pre-loaded SD card to Re-flash Unit.

- 1. Insert Pre-loaded SD card to the unit.
- 2. Reset the unit and enter the bootloader mode, by pressing Press Capture simultaneously and Reset the unit.

Display will show....

Restore ALL image from SD
Press Voice dial Key
To start Download

Download SD image?

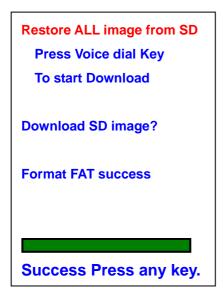
Format BINFS success

Restore ALL image from SD
Press Voice dial Key
To start Download

Download SD image?

Format BINFS success

3. Once it is done, display will show



- 5. Take out the SD card and Cold boot the device (unit).
- 6. Press "Power + Reset" to cold boot the device (unit)

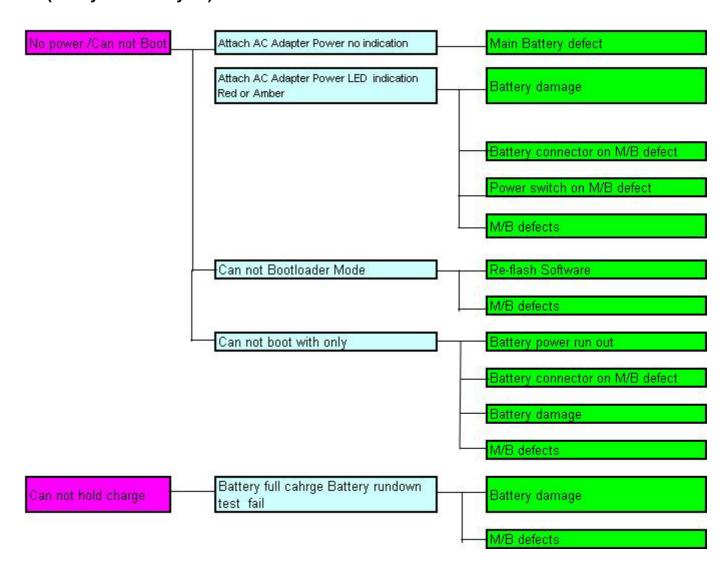
Now the upgrade is done!

Note: Due to security issue, it is not allowed to re-flash different customer ID.



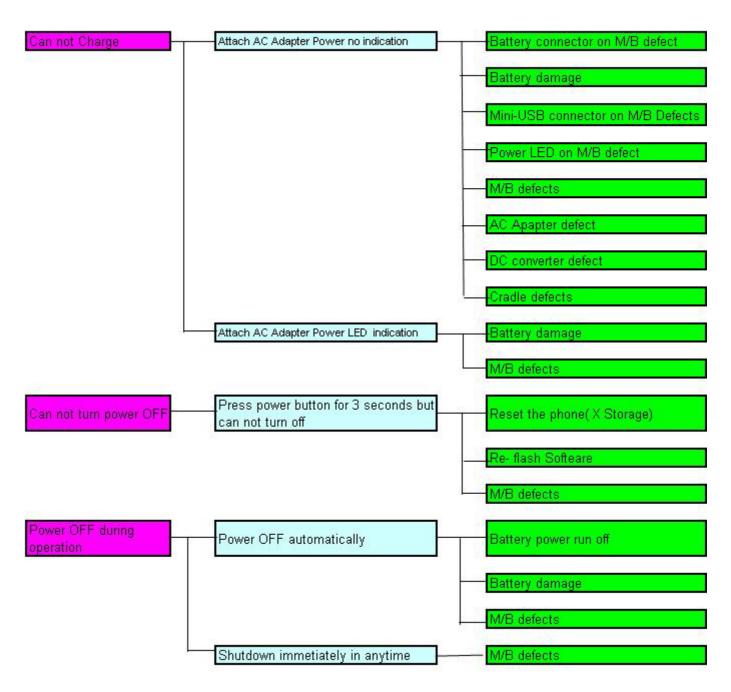


9. FTA (Faulty Tree Analysis)



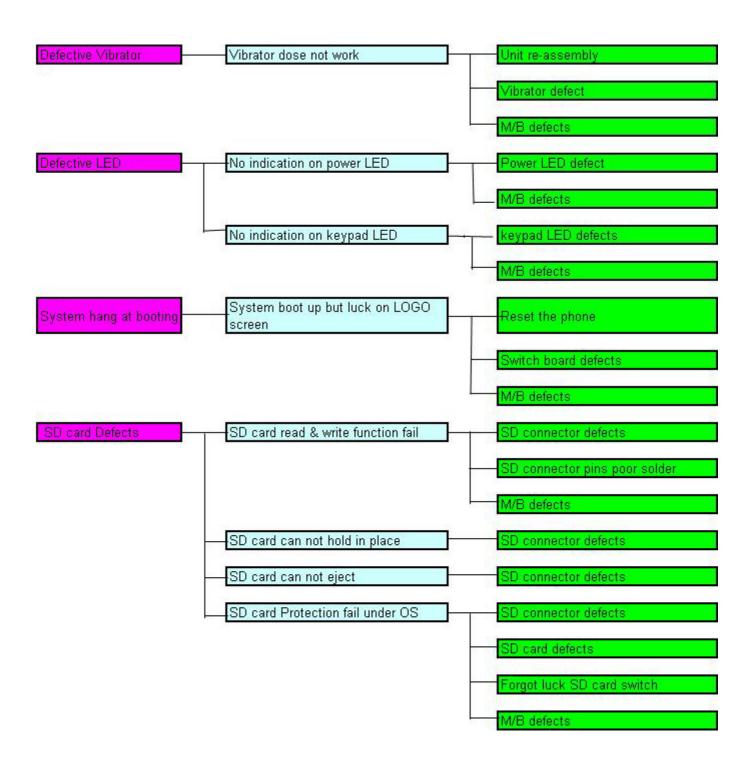






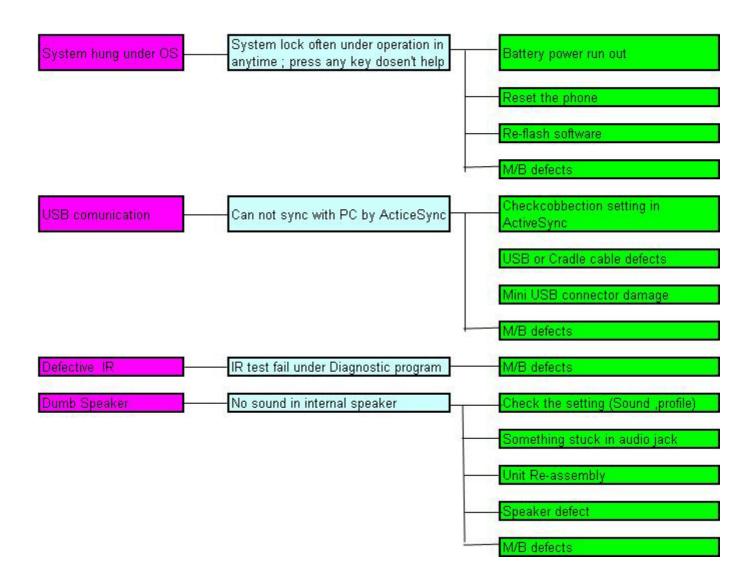






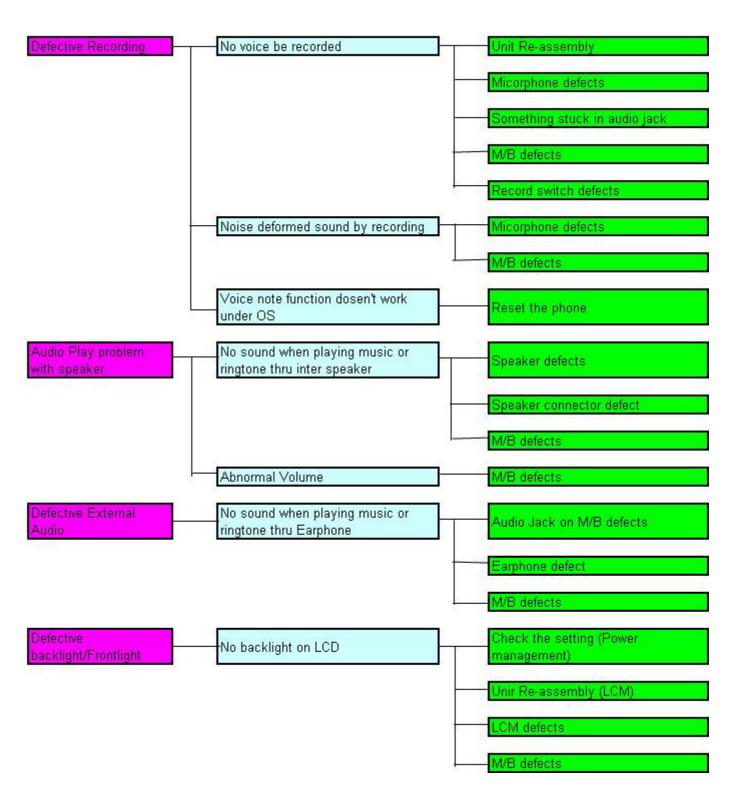






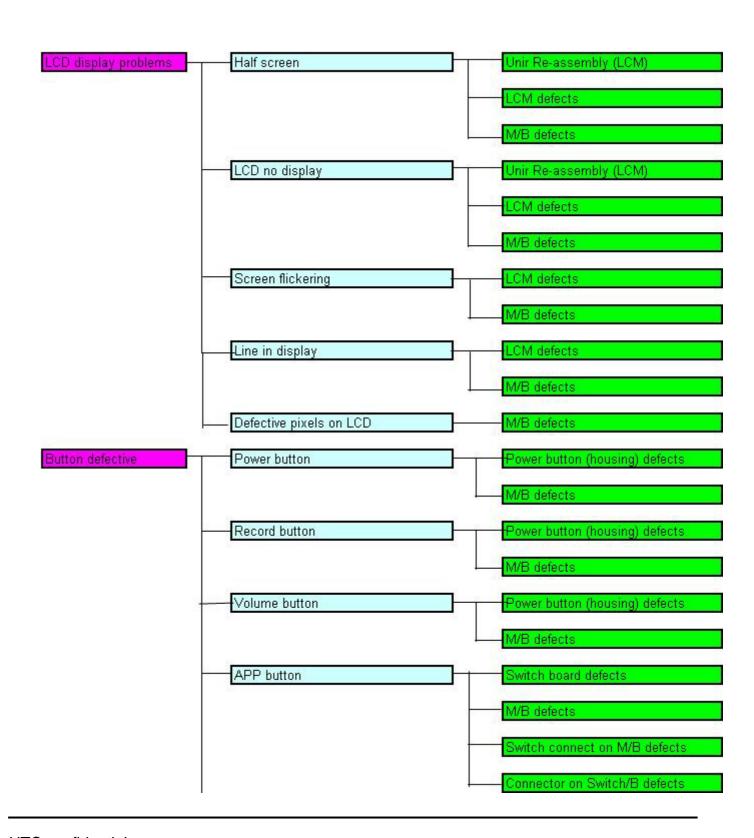






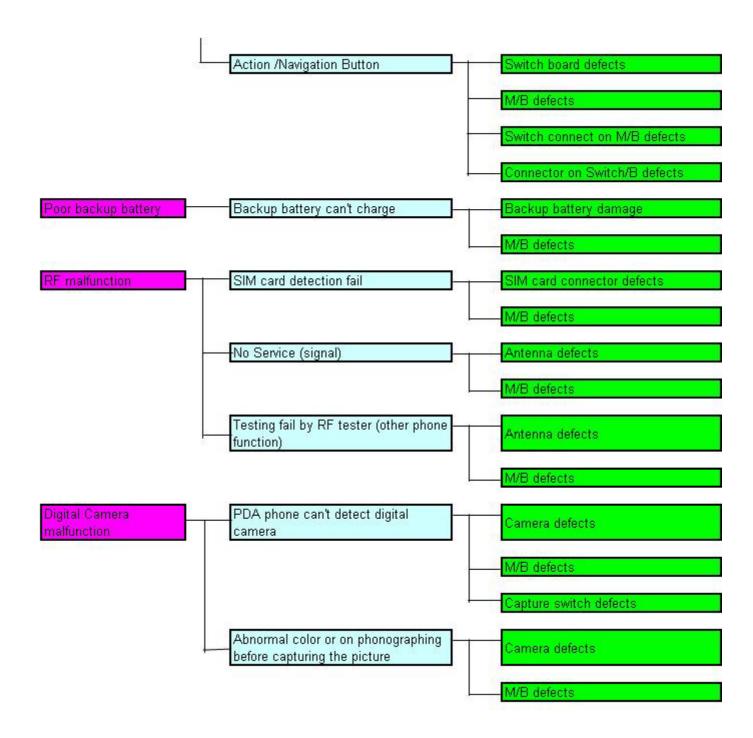












10. Spare Part List





Charmer Part List

Item	HTCP/N	Description
1	35H00051-00	Rechargeable LI-ION Battery,1200mAh,3.7V,DAK500130-00B801,DynaPack,Magician
2	36Н00180-00М	Vibrator, Cylinder type, A4A-05-WTB-3, C.I. Kasei, dia. 4mm shell, dia. 5mm c.w., w/rubber
3	36Н00253-01М	Receiver,8mm receiver with tape,WD20398/32,2403 263 00007,PHILIPS
4	36Н00338-00М	Speaker,SAMBU,SBD201538P-CC01,20*15*3.8mm,Charmer
5	36Н00345-00М	Antenna Pre-Assy, AMPHENOL, GAN40028A, CHARMER
6	51 н00320-02 м	PCBA-MAIN BOARD,Samsung LCM,1.3M Camera,CHARMER
7	51H00322-00M	PCBA,AUDIO BOARD,CHARMER
8	54H00134-01M	Module Assy, PREMIER, HTC-NBR149, OV9653+Largan 796, 9.1*9.1*7.59mm
9	60Н00032-00	LCD Module,LTP280QV-E01,Samsung
10	71Н00960-00М	Holder, Audio-jack,PC,Magician
11	71H01279-02M	Cover, Battery, Gray, T-Mobile, Charmer
11A	71H01279-03M	Cover, Battery, Pink, T-Mobile, Charmer
11B	71H01279-01M	Cover,Battery,Dark Blue,T-Mobile,Charmer-O3
12	72H00339-00	SCREW,TORX,M1.6x8,NYLOK,L4.5
13	72H00498-00M	GASKET,AUDIO_RF,Pb-FREE,Vivida
14	72H00548-00	Gasket,5*3.5*10mm,630GT,NAUTILUS
15	72H00724-00M	Screw,PH,FD,T1.4*2.9, Nickel,Black,AISI 1018
16	72Н00782-00М	Copper Foil, LCM, Magician
17	72H01134-00M	EMI Gasket,SD-Holder,U-TEK,Charmer
18	73Н20034-15М	FPC Pre-Assy, Switch Board, AFLEX, CHARMER, 59.21*19.99*0.2mm
19	74H00371-13M	Bezel Pre-Assy,Gray,T-Mobile,Charmer-O3
19A	74H00371-14M	Bezel Pre-Assy, Pink, T-Mobile, Charmer-O3
19B	74H00371-12M	Bezel Pre-Assy,Dark Blue,T-Mobile,CHARMER
20	74Н00375-04М	Cover Pre-Assy, Antenna, Gray, T-Mobile, Charmer-O3
20A	74Н00375-05М	Cover Pre-Assy, Antenna, Pink, T-Mobile, Charmer-O3
20B	74H00375-03M	Cover Pre-Assy, Antenna, Dark Blue, T-Mobile, Charmer-O3
21	74Н00399-00М	Stylus Pre-Assy,Nylon+Copper+POM,Magician
22	74Н00400-00М	Keypad Navigation Pre-Assy, Magician
23	74Н00534-00М	Housing Pre-Assy, CHARMER
24	76Н00398-01М	rubber-cover, antenna-cover, gray, Himalayas
25	76Н00967-00М	Mylar for LCD, Magician
26	76Н00724-00М	Tape for keypad support, Typhoon
27	76Н00748-00М	Spacer,rubber,Switch,Silicon,Magician
28	76Н00749-00М	Rubber, Camera, S1, Poron, Magician
29	76Н00754-00М	Mylar,Battery Connector,Magician
30	76Н01088-00М	Rubber, Microphone, Silicone, Charmer
31	76н01093-00м	Conductive Gasket, Shielding-back, Charmer
32	76Н01131-00М	Mylar, LCM-SD, CHARMER
33	77H00222-00M	Label security, Magician
34	77Н00311-00М	Regulation Label,41*35mm,MING JYE,Charmer
35	77H00203-00	Water Sensitive Label,4*2.5mm,Ming Jye,BlueAngels





11. Spare Part Photo

35H00051-00		36H00180-00M	The state of the s	36H00345-00M	
Main Battery		Vibrator		Antenna	
Q'ty:1		Q'ty:1		Q'ty:1	*ALLIANCE
36H00338-00M		36H00253-01M		51H00320-02M	
Speaker Assy		Receiver		Main Board	S. Commission
Q'ty:1		Q'ty:1		Q'ty:1	-
541100000 0000		544004040404		60H00032-	
51H00322-00M	- O. C. C. C.	54H00134-01M Camera		00/60H00037-00M	
Audio Daughter Board		Module		LCM Samsung	
Q'ty:1		Q'ty:1		Q'ty:1	
Q ly . 1		Gry . I		Griy . 1	
71H00960-00M		76H00398-01M		72H00339-00	
7 11100000 00111		rubber-cover,		721100000	
		antenna-cover,		Screw TORX M1	ľ
Holder Audio Jack	100 Marie	gray		6*8	
Q'ty:1		Q'ty:1		Q'ty:4	
					ataznate atategin apeatach apeapeagnade photos becker
72H00498-00M		72H00548-00		72H00724-00M	
GASKET	100	Gasket 5*3.5*10mm		Screw PH FD	-
Audio RF				T1.4*2.9	-34
Q'ty:1		Q'ty:1		Q'ty:6	
721100702-0055	3 3 M	721120024 4584		741100524-0045	The second second
72H00782-00M		73H20034-15M	A STATE OF THE PARTY OF THE PAR	74H00534-00M Housing Pre-	
Copper Foil LCM		Switch FPC Assembly		Assembly	William William
Q'ty:1		Q'ty:1		Q'ty:1	M 17
74H00371-13M		74H00374-XXM		74H00375-04M	-
Bezel Assembly		Cover Battery		Cover Antenna	•
Dezerrasemoly		Oover Dattery		OVER MIRCINIA	(P) (S)
Q'ty:1		Q'ty:1		Q'ty:1	





74H00399-00M		74H00400-00M		76H00748-00M	
Stylus		Keypad Navigation		Spacer Rubber	
Q'ty:1		Q'ty:1		Q'ty:1	
76H00749-00M		76H00754-00M		76H01088-00M	
Rubber camera		Mylar Battery Connector		Boot Microphone	B
Q'ty:1		Q'ty:1	-ettition.	Q'ty:1	
77H00222-00M		71H00651-00M DUMMY,SD,CARD,		72H00831-00M Dome Metal Switch	Patrick States
Security label		HIMALAYAS Qty: 1		Magician,SUS-301	
Q'ty:1		· ·		Q'ty:1	
77H00203-00 Water Sensitive Label,4*2.5mm,Mi ng Jye, BlueAngels	CO COUNTY OF THE	36H00310-00M Earphone,EACETECH,TS 888-03206N-\MA-01ZS	3	76H01093-00M Conductive Gasket,Shielding- back,Charmer	A los
Q'ty:1	・超速ニー	Q'ty:1		Q'ty : 1	
76H00131-00M		72H01134-00M			
Mylar,LCM- SD,CHARMER		EMI Gasket,SD- Holder,U-TEK,Charmer	of the last		
Q'ty : 1		Q'ty:1	0		





Appendix

A. Customer, Retailer Misjudgment

Before attempt repairing the unit, make sure the type of reported failure could be clearly reproduced; otherwise, check with the customer or distributor once again to identify the problem correctly.

The following are failure symptoms that are typical by misjudgment

No.	Item	Possibility
		Main Battery low power exhausted.
	No Power even the power	While Back Light is turned OFF, the surrounding lighting will be reflected on the
1	button is pressed	panel and in a dim location, it looks like the unit is turned OFF.
		According to the Power Management settings, the units will be switched OFF
		automatically.
		The battery life depends on the devices being used in SD Card Slot, and
2	Battery discharges quickly	frequency of use of the Backlight. These functions consume a lot of energy.
	Battery discriarges quickly	Operating with front light ON, or using high-energy consumption devices such as
		SD Memory Card will drain out the battery pack faster.
		Using AC adapter that is NOT supplied with the unit.
		Charging the battery while operating the unit with heavy loadings could cause the
	Battery cannot be charged	temperature inside the unit to build up which could cause the unit stop charging. At
3		this moment, the LED indicator will flash Yellow to notify user that the charging has
		been stopped. Or the temperature is extremely low will also stop charging.
		Since the extreme high or low temperature will cause the battery to discharge
		quickly, it has been designed to cut battery charge below 0 and above 35~40
		to protect the battery pack.
	Cannot make	If the unit could pass the test with Loop back Interface card, the possibility of unit
4	communications via mobile	malfunction becomes low. Then the following items could be the reason of
-	phones through exclusive	problem such as location, timing, signal strength, service provider's mixed up, or
	cable.	problem with the mobile itself. Or could be incompatibility issue.
	Cannot use SD	Card is not being pre-formatted.
5	Memory Card	SD card has been switched to Write Protect mode.
	Women's Cara	Card not inserted completely, or bad contact between connector contacts.
	Black or White dot on the	For LCD panel's normal behavior, it is hard to find a panel without any bad pixel.
6	screen.	Once the numbers of dots and the distance between them are within the
	30,001.	specifications, it is allowed.





7	Touch Screen or Program	Could be wrong operation.			
	Buttons are not reacting.	Screen not properly aligned with the stylus calibration.			
	Front Light dim, cannot turn				
8	ON, or shuts OFF	Check the Front Light settings in Power Management settings			
	automatically.				
9	Cannot playback music, No	When Battery low, the music playback becomes difficult and the volume could			
9	sound or volume is low.	become lower.			
10	Cannot execute installed	Could be an incompatible astructo			
10	application programs	Could be an incompatible software			
11	Operation is slow in	Could be insufficient memory. Check amount of system memory.			
11	response	Could be insufficient memory. Check amount of system memory.			
		Software being used sometimes is not fully compatible with the system.			
12	Hongup	Execute many application programs simultaneously			
12	Hang up	Software that requires big amount of memory spaces or the system memory is low			
		or the files being used is fragmented.			
	Custom Moment is anough	Coffware that requires his amount of mamon, analog or the system mamon, is law.			
13	System Memory is enough,	Software that requires big amount of memory spaces or the system memory is low			
	but is shows insufficient.	or the files being used is fragmented.			

^{*}Note: Nevertheless, the above symptoms could be solved by a warm boot or cold boot, make sure the warm/cold boot has been executed and try to reproduce the symptom reported.

How to perform Warm Boot and Cold Boot:

Warm Boot: Reset the unit by pressing reset button.

Cold Boot: Press Power + Reset the unit simultaneously.





B. Labeling Plan (Generic)

B.1 Main unit Regulatory label (on the rear housing of main unit)

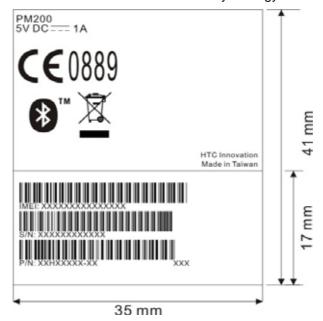
It includes:

- Unit IMEI & Barcode
- Unit Serial Number & Barcode
- Unit Part Number & Barcode

Image file name: MAIN_UNIT_REGULATION

Please note: 1. The brand name is shown on Bezel.

2. All bar codes must be code128 symbology.







B.2 Definition of Serial Number

For S/N: **SSYWWPPZZZZZ**

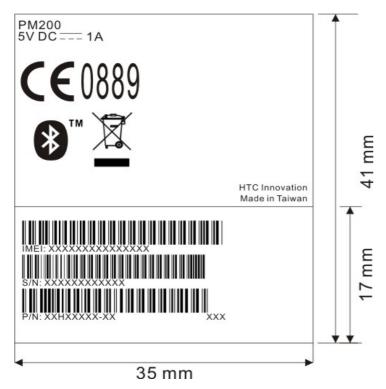
SS: SITE CODE → HT

Y: Year Last Digital of the Year.

WW: Week Code: **01 ~ 54**

PP: Product Code: BD

ZZZZZ: Serial Number (00001 ~ 99999) Use Base 10



Label Characteristic: Material: polyester Color: pantone 422c Ink: pantone 425c





C. RF Antenna Test Specification

Items	Test Name	TxLevel	тсн	lst Downlink CellPower	Note
1	Camp @ DCS Band	0	512	-75	BCCH=600
2	BS Originate Call	0	512	-75	
	E-GSM	900 ReceiverTest			
3	Fast Bit Error Rate	5	975	-104	
4	Fast Bit Error Rate	5	42	-104	
5	Fast Bit Error Rate	5	124	-104	
	E-GSM 9	00 Ttansmitter Te	st		
6	TX Phase RMS Error	5	975	-104	
7	TX Phase Peak Error	5	975	-104	
8	TX Frequency Error	5	975	-104	
9	TX Phase RMS Error	5	42	-104	
10	TX Phase Peak Error	5	42	-104	
11	TX Frequency Error	5	42	-104	
12	TX Phase RMS Error	5	124	-104	
13	TX Phase Peak Error	5	124	-104	
14	TX Frequency Error	5	124	-104	
15	15 Check TX Power		975	-104	
16	16 Check TX Power		42	-104	
17	Check TX Power	5	124	-104	





	DCS 1800 ReceiverTest						
1	Fast Bit Error Rate	0	512	-104			
2	Fast Bit Error Rate	0	<i>6</i> 98	-104			
3	Fast Bit Error Rate	0	8885	-104			
	DCS 180	00 Ttansmitter Tes	t				
4	TX Phase RMS Error	0	512	-104			
5	TX Phase Peak Error	0	512	-104			
6	TX Frequency Error	0	512	-104			
7	TX Phase RMS Error	0	<i>6</i> 98	-104			
8	TX Phase Peak Error	0	<i>6</i> 98	-104			
9	TX Frequency Error	0	<i>6</i> 98	-104			
10	TX Phase RMS Error	0	885	-104			
11	TX Phase Peak Error	0	885	-104			
12	TX Frequency Error	0	885	-104			
13	Check TX Power	0	512	-104			
14	Check TX Power	0	<i>6</i> 98	-104			
15	Check TX Power	0	885	-104			

	PCS 1900 ReceiverTest						
1	Fast Bit Error Rate	0	512	-104			
2	Fast Bit Error Rate	0	661	-104			
3	Fast Bit Error Rate	0	810	-104			
	PCS 190	0 Ttansmitter Tes	t				
4	TX Phase RMS Error	0	512	-104			
5	TX Phase Peak Error	0	512	-104			
6	TX Frequency Error	0	512	-104			
7	TX Phase RMS Error	0	661	-104			
8	TX Phase Peak Error	0	661	-104			
9	TX Frequency Error	0	661	-104			
10	TX Phase RMS Error	0	810	-104			
11	TX Phase Peak Error	0	810	-104			
12	TX Frequency Error	0	810	-104			
13	Check TX Power	0	512	-104			
14	Check TX Power	0	661	-104			
15	Check TX Power	0	810	-104			





	GSM 850 ReceiverTest						
1	Fast Bit Error Rate	0	128	-104			
2	Fast Bit Error Rate	0	189	-104			
3	Fast Bit Error Rate	0	251	-104			
	GSM 85	0 Ttansmitter Tes	t				
4	TX Phase RMS Error	0	128	-104			
5	TX Phase Peak Error	0	128	-104			
6	TX Frequency Error	0	128	-104			
7	TX Phase RMS Error	0	189	-104			
8	TX Phase Peak Error	0	189	-104			
9	TX Frequency Error	0	189	-104			
10	TX Phase RMS Error	0	251	-104			
11	TX Phase Peak Error	0	251	-104			
12	TX Frequency Error	0	251	-104			
13	Check TX Power	0	128	-104			
14	Check TX Power	0	189	-104			
15	Check TX Power	0	251	-104			

D. Board Level 2.5 Repairs

A. Components to be replaced

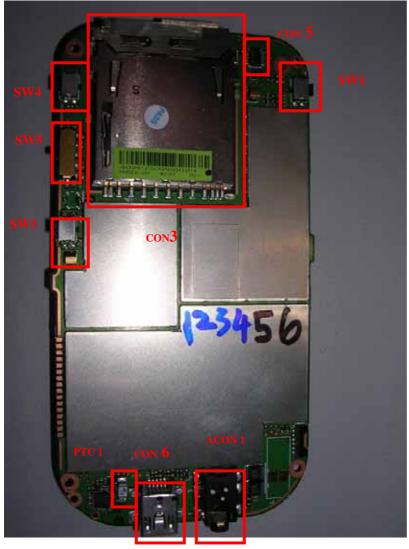
I. Main Board: ONLY the following items have been allowed to replace for M/B.

Obverse side

- 1. SD Card Slot (CON3)
- 2. Audio daughter Connector (CON5)
- 3. Power Switch (SW1)
- 4. Capture Switch (SW4)
- 5. Volume Slide Switch (SW5)
- 6. Record Switch (SW3)
- 7. Mini-USB connector (CON6)
- 8. Audio Jack (ACON1)
- 9. FUSE (PTC1)







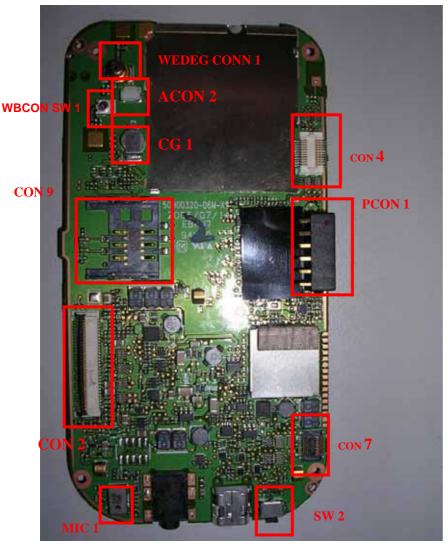
Reverse side

- 1. Connector RF, WEDEG (WEDEG CONN1)
- 2. Speaker connector (ACON2)
- 3. Battery Connector (PCON1)
- 4. SIM Card Connector (CON9)
- 5. LCM connector (CON2)
- 6. COAXIAL CONNECTOR (WBCON_SW1)
- 7. Reset Key (SW2)
- 8. Switch board connector (CON7)
- 9. Gold Cap,0.07F,70ohm, 3.3V (CG1)





- 10. Camera connector (CON4)
- 11. MIC (MIC1)



- **B. Problem Identification & Troubleshooting**
- I. Basic Repair Instructions for Component Replacement:
 - **Step 1**. Place the solder-proof tape to cover the surrounding area of the components which being replaced.

Warning: DO NOT overheat the tape and components to avoid the tape melted and make the component damage.

- Step 2 Use Heater Gun (HAKO850B, set the temperature between 350 , Air Speed 3~5) to remove the components.
- Step 3 It has to wait the temperature cool down before the damaged components been removed. Or, the others





components could be gone when the solder-proof tape been taken off.

- **Step 4** After the damaged components has been replaced; clean the surroundings for solder and flux residues.
- II. Main Board: The following items have been allowed to replace for Main Board
- 1. Recording Switch (SW3), Camera Switch (SW4), Reset Switch (SW2), Power Switch (SW 1)

 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 1.1 If the switch still doesn't work properly after replace new one, please replace the M/B.

2. Camera FPC Connector (CON4)

- 2.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 2.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

3. Mini-USB Connector (CON6)

- 3.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 3.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

4. Audio Jack (ACON 1)

- 5.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 5.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

5. LCD FPC Connector (CON2)

- 5.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 5.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 5.3 Place solder-proof tape on CON2 to prevent it melted when using heater gun to remove CON2.

6. Switch Board FPC Connector (CON7)

- 6.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 6.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 6.3 Place solder-proof tape on CON6 to prevent it melted when using heater gun to remove CON6

7. Battery Connector (PCON 1)

- 7.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 7.2 If the connector still doesn't work properly after replace new one, please replace the M/B.





8. Gold Cap (CG1)

8.1 If the Golden cap function failure (can not keep the date, RTC failure) replace it.

Replace process:

- A. Remove CG1 (DO NOT use Heater Gun to remove)
- B. Take a new one for replace:
- Notice: 1. Set up the welding iron temperature 350 degree C
 - 2. Don't stay on the pins (positive and negative pin) of component (CG1) over 5 seconds.
 - 3. Don't contact the component body with welding iron directly.
- 8.2 If the component doesn't work properly after replace new one, please replace the M/B.

9. SIM Card Connector (CON 9)

- 9.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 9.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 9.3 Use solder iron only to replace new component. DO NOT use Heater Gun to remove component to prevent next connector melted.

10. WEDEG RF connector (WEDEG CONN1)

- 10.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 10.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

11. FUSE (PTC 1)

- 11.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 11.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

12. Volume Control Switch (SW5)

- 12.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 12.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

13. SD Card Slot (CON3)

- 13.1 If the slot is broken, warp or doesn't work properly (measure by scope), replace it.
- 13.2 If the slot still doesn't work properly after replace new one, please replace the M/B.





B. Charmer Spare Part List For Board Level Repair

Charmer BOARD LEVEL Spare part List

Item	Description	HTC P/N	Using		
	·		Q'ty	Location	Remark
1	36H00129-00M	SWITCH BUTTON,PTS-106,HCH,4.7*4.5*1.65	4	SW1,2,3,4	
2	36H00160-00M	Slide_Switch,HSS112,HCH 1	1	SW5	
3	36H00208-00M	MIC,SP0103NC3,EMKAY,Pb-FREE,100/-40degC,6.15*3.76*1.45 mm 1	1	MIC1	
4	36H00301-00M	Fuse,PTC,1.5A, 6V 0.04 ohm~0.12 ohm,0.08ohm,+/-50%,1206	1	PTC1	
5	36H00256-00M	2.5 MM AUDIO JACK,DTJ-0281,12.5* 7 *4 MM,DIHTAIN 1	1	ACON1	
6	75H00204-00M	CONNECTOR,B-TO-FPC,FH23-61S-0.3SHAW(05),PITCH=0.6mm,HRS	1	CON2	
7	75H00228-00M	CONNECTOR,SM02B-SURS-TF,JST 1	1	ACON2	
		COAXIAL CONNECTOR,RF,WITH		WBCON_	
8	75H00248-00M	SWITCH,SMD,MM8430-2600RA1,MURATA	1	SW1	
		Connector			
9	75H00450-00M	SDIO,15P,2.5mmPitch,0.5A,AXA29200933,MATSUSHITA	1	CON3	
10	751 100224 00M	Connector DE 4D LDC TD 4 400000 0400 ITT Connect Db EDEE	4	WEDGE	
10	75HUU321-UUWI	Connector RF,4P,LPC TP-1,120220-0129,ITT Cannon, Pb-FREE	1	CONN1	
11	75H00395-00M	Connector SIM Card,50mohm,ICC-429,hamburg	1	CON9	
12	75H00396-00M	Connector,Battery,6PIN,Pitch=2.5mm,R-angle,BTR1M-6K2000,Acon	1	PCON1	
13	75H00397-00M	Connector B to B,22P,0.5pitch,AXK5F22345Y,MATSUSHITA	1	CON4	
		Connector I/O male mini uph MNE44 ECED10, type ab etraddle		CO144	
14	75H00400-00M	Connector I/O,male,mini-usb,MNE41-5G5P10, type ab, straddle	1	CON6	
		type,ACON		CONO	
15	75H00402-00M		1	CONZ	
		B,AXK814145Y,70mohm,14P,P=0.4mm,0.3A,60V,Matsushita		CON7	
16	75H00415-00M	Connector B to B,Female,20pin,Pitch=0.4mm,AXK7L20227,Matsushita	1	CON6	
17.	16H00012-00M	Gold Cap,0.07F,70ohm,3.3V,-25/+50%,XH414H II02EY,SEIKO,	.1	CG1	